

**Surface Mount Schottky Barrier Rectifier**
**Reverse Voltage - 40 to 60 V**
**Forward Current - 3 A**
**FEATURES**

- ◆ Metal silicon junction, majority carrier conduction
- ◆ For surface mounted applications
- ◆ Low power loss, high efficiency
- ◆ High forward surge current capability
- ◆ For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives


**Pinning**

1.Cathode	2.Anode
	2 
<b>SMAF</b>	
<b>Marking Code</b>	
SSL34F	SSL34
SSL36F	SSL36

**MECHANICAL DATA**

- ◆ Case: SMAF
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026
- ◆ Approx. Weight: 27mg / 0.00095oz

**Absolute Maximum Ratings and Electrical characteristics**

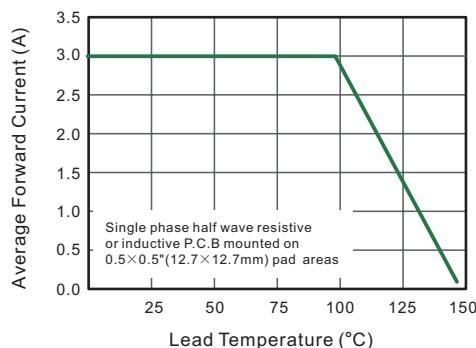
Ratings at 25 ° ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	SSL34F	SSL36F	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	40	60	V
Maximum RMS voltage	$V_{RMS}$	28	42	V
Maximum DC Blocking Voltage	$V_{DC}$	40	60	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	3.0		A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed On Rated Load (JEDEC method)	$I_{FSM}$	80	70	A
Maximum Instantaneous Forward Voltage at 3 A	$V_F$	0.45	0.5	V
Maximum Instantaneous Reverse Current $T_A = 25^\circ C$ at Rated DC Reverse Voltage $T_A = 100^\circ C$	$I_R$	0.3 5	0.5 5	mA
Typical Junction Capacitance <sup>(1)</sup>	$C_J$	450	400	pF
Typical Thermal Resistance <sup>(2)</sup>	$R_{θJA}$	50	60	°C/W
Operating Junction Temperature Range	$T_J$	-55 ~ +125		°C
Storage Temperature Range	$T_{stg}$	-55 ~ +150		°C

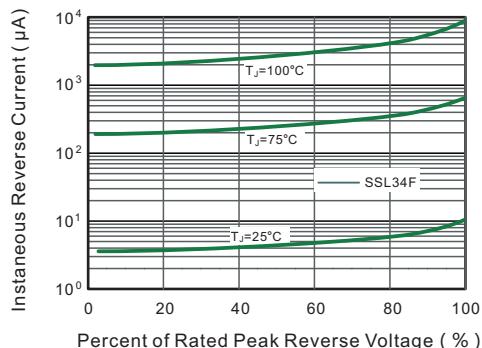
(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

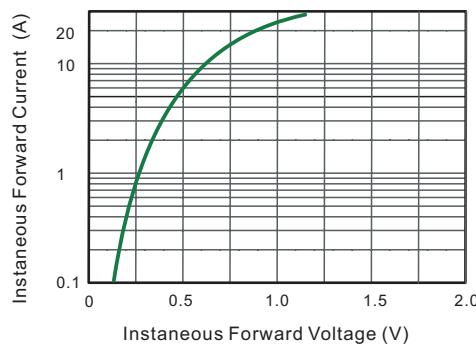
**Fig.1 Forward Current Derating Curve**



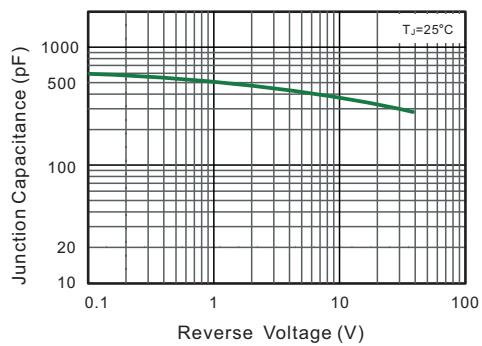
**Fig.2 Typical Reverse Characteristics**



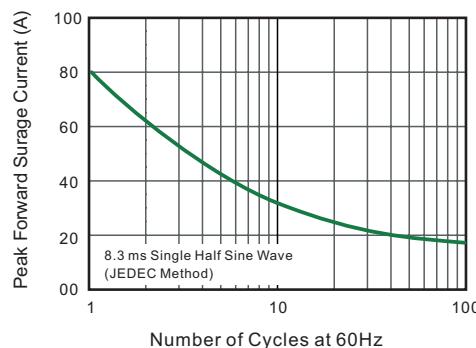
**Fig.3 Typical Forward Characteristic**



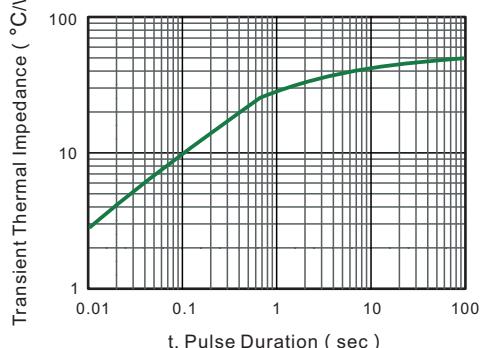
**Fig.4 Typical Junction Capacitance**



**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**



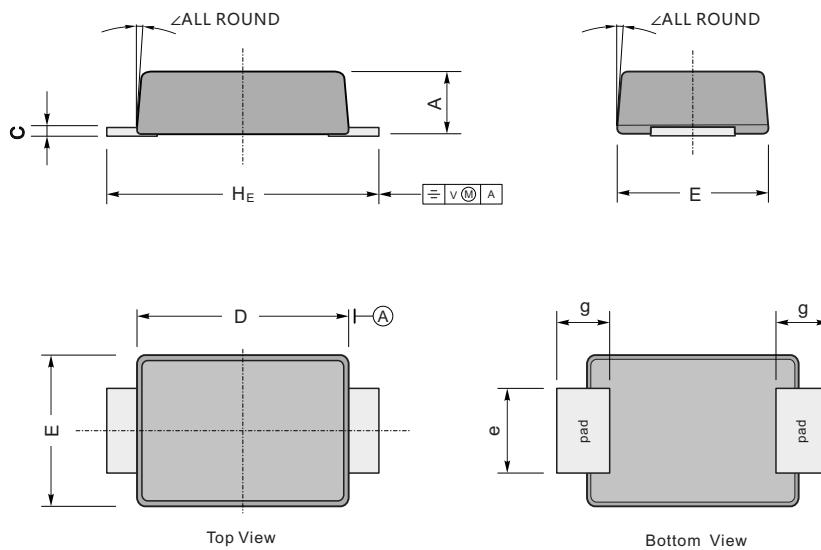
**Fig.6- Typical Transient Thermal Impedance**



### Package Outline

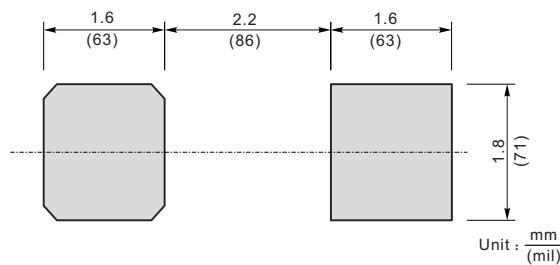
**SMAF**

Plastic surface mounted package; 2leads



UNIT		A	C	D	E	e	g	H <sub>E</sub>	∠
mm	max	1.1	0.20	3.7	2.7	1.6	1.2	4.9	7°
	min	0.9	0.12	3.3	2.4	1.3	0.8	4.4	
mil	max	43	7.9	146	106	63	47	193	7°
	min	35	4.7	130	94	51	31	173	

### The recommended mounting pad size



### Summary of Packing Options

Package	Packing Description	Packing Quantity	Industry Standard
SMAF	Tape/Reel, 13" reel	10000	EIA-481-1
	Tape/Reel, 7" reel	3000	EIA-481-1